

# BC337, BC337-16, BC337-25, BC337-40, BC338-25

## Amplifier Transistors

### NPN Silicon

#### Features

- Pb-Free Package is Available\*

#### MAXIMUM RATINGS

Rating	Symbol	BC337	BC338	Unit
Collector–Emitter Voltage	$V_{CEO}$	45	25	Vdc
Collector–Base Voltage	$V_{CBO}$	50	30	Vdc
Emitter–Base Voltage	$V_{EBO}$	5.0		Vdc
Collector Current – Continuous	$I_C$	800		mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	625 5.0		mW mW/°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.5 12		W mW/°C
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	–55 to +150		°C

#### THERMAL CHARACTERISTICS

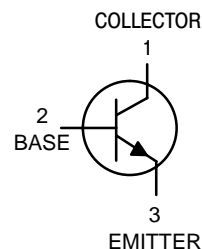
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction–to–Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction–to–Case	$R_{\theta JC}$	83.3	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



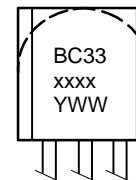
ON Semiconductor®

<http://onsemi.com>



TO-92 (TO-226)  
CASE 29

#### MARKING DIAGRAM



xxxx = Specific Device Code  
Y = Year  
WW = Work Week

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# BC337, BC337-16, BC337-25, BC337-40, BC338-25

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector–Emitter Breakdown Voltage ( $I_C = 10\text{ mA}$ , $I_B = 0$ ) BC338	$V_{(BR)CE\ O}$	45 25	– –	– –	Vdc
Collector–Emitter Breakdown Voltage ( $I_C = 100\ \mu\text{A}$ , $I_E = 0$ ) BC338	$V_{(BR)CE\ S}$	50 30	– –	– –	Vdc
Emitter–Base Breakdown Voltage ( $I_E = 10\ \mu\text{A}$ , $I_C = 0$ )	$V_{(BR)EB\ O}$	5.0	–	–	Vdc
Collector Cutoff Current ( $V_{CB} = 30\text{ V}$ , $I_E = 0$ ) ( $V_{CB} = 20\text{ V}$ , $I_E = 0$ )	$I_{CBO}$	– –	– –	100 100	nAdc
Collector Cutoff Current ( $V_{CE} = 45\text{ V}$ , $V_{BE} = 0$ ) ( $V_{CE} = 25\text{ V}$ , $V_{BE} = 0$ )	$I_{CES}$	– –	– –	100 100	nAdc
Emitter Cutoff Current ( $V_{EB} = 4.0\text{ V}$ , $I_C = 0$ )	$I_{EBO}$	–	–	100	nAdc

## ON CHARACTERISTICS

DC Current Gain ( $I_C = 100\text{ mA}$ , $V_{CE} = 1.0\text{ V}$ )  ( $I_C = 300\text{ mA}$ , $V_{CE} = 1.0\text{ V}$ )	BC337 BC337-16 BC337-25/BC338-25 BC337-40	$h_{FE}$	100 100 160 250 60	– – – – –	630 250 400 630 –	–
Base–Emitter On Voltage ( $I_C = 300\text{ mA}$ , $V_{CE} = 1.0\text{ V}$ )		$V_{BE(on)}$	–	–	1.2	Vdc
Collector–Emitter Saturation Voltage ( $I_C = 500\text{ mA}$ , $I_B = 50\text{ mA}$ )		$V_{CE(sat)}$	–	–	0.7	Vdc

## SMALL-SIGNAL CHARACTERISTICS

Output Capacitance ( $V_{CB} = 10\text{ V}$ , $I_E = 0$ , $f = 1.0\text{ MHz}$ )	$C_{ob}$	–	15	–	pF
Current–Gain – Bandwidth Product ( $I_C = 10\text{ mA}$ , $V_{CE} = 5.0\text{ V}$ , $f = 100\text{ MHz}$ )	$f_T$	–	210	–	MHz

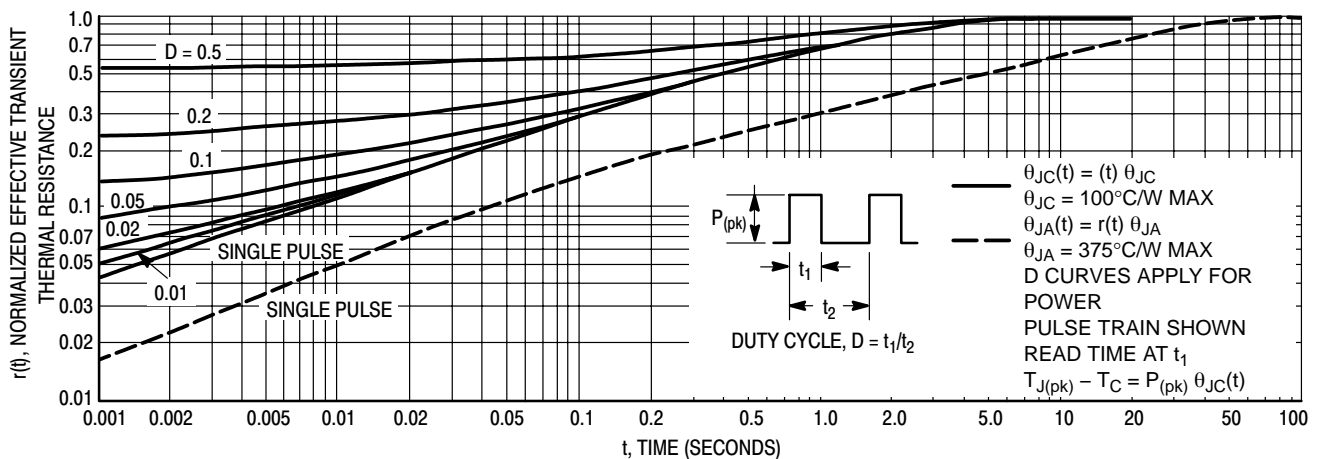


Figure 1. Thermal Response

# BC337, BC337-16, BC337-25, BC337-40, BC338-25

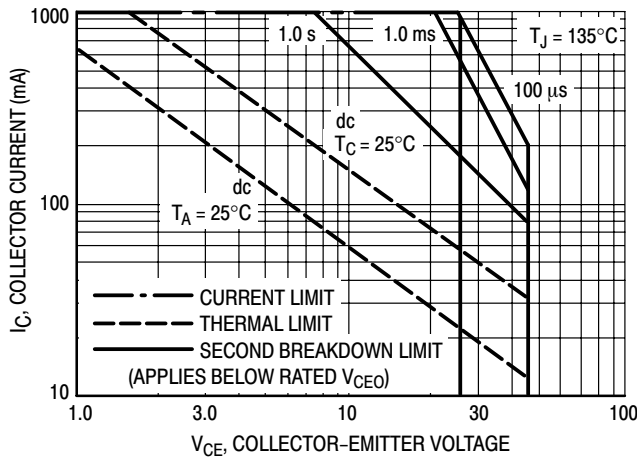


Figure 2. Active Region – Safe Operating Area

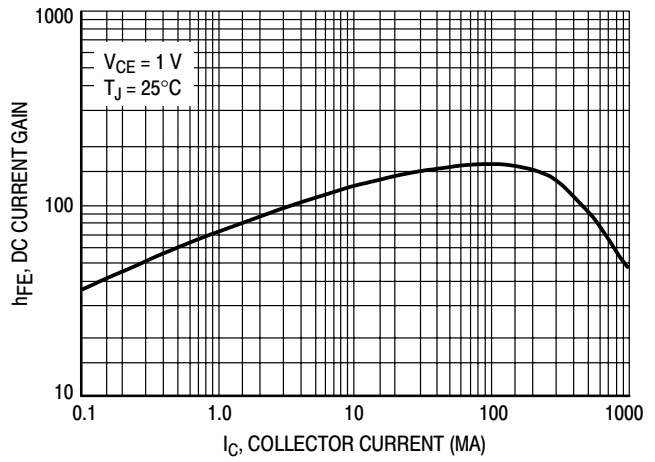


Figure 3. DC Current Gain

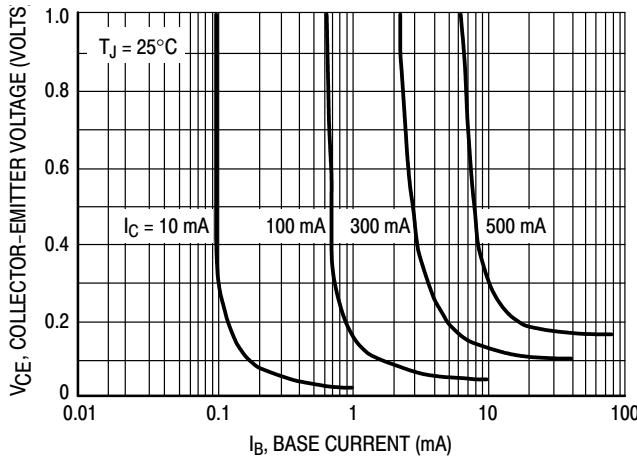


Figure 4. Saturation Region

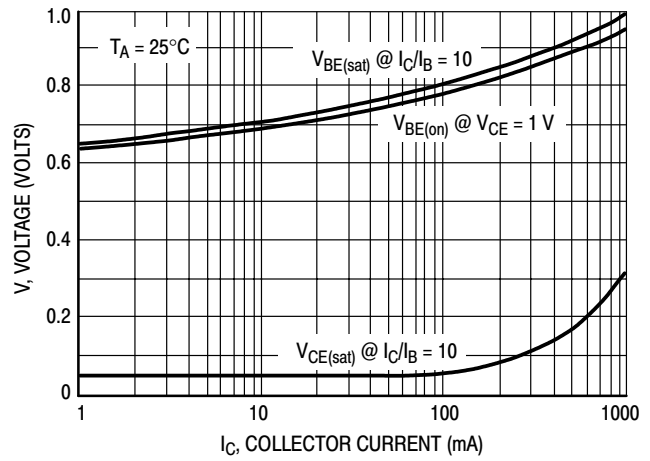


Figure 5. “On” Voltages

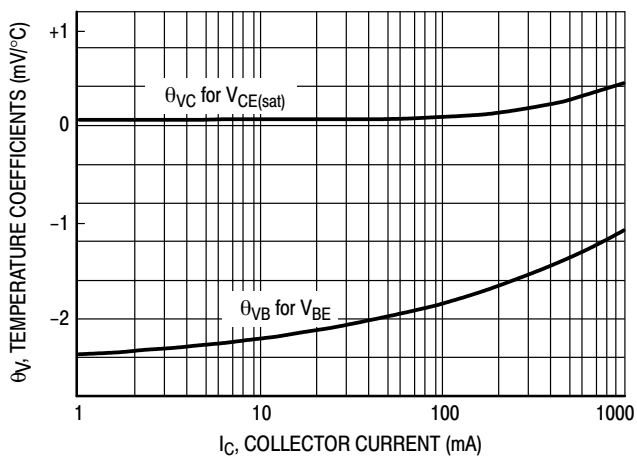


Figure 6. Temperature Coefficients

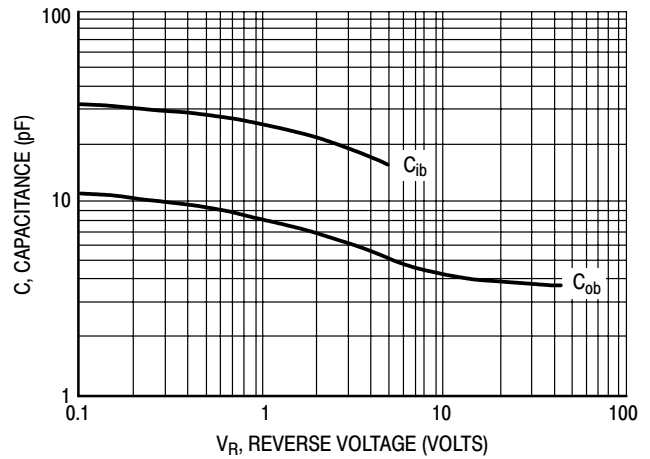


Figure 7. Capacitances

## BC337, BC337-16, BC337-25, BC337-40, BC338-25

### ORDERING INFORMATION

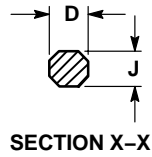
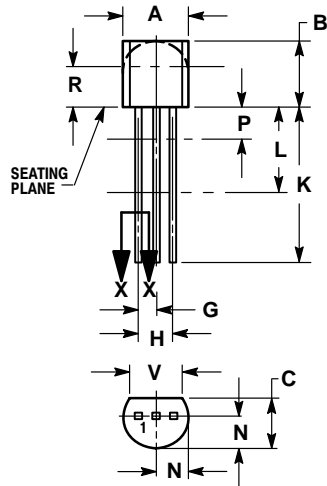
Device	Package	Marking	Shipping <sup>†</sup>
BC337	TO-92	7	5000 Units / Bulk
BC337RL1	TO-92	7	2000 / Tape & Reel
BC337ZL1	TO-92	7	2000 / Tape & Ammunition
BC337-16	TO-92	7-16	5000 Units / Bulk
BC337-16RL1	TO-92	7-16	2000 / Tape & Reel
BC337-16ZL1	TO-92	7-16	2000 / Tape & Ammunition
BC337-25	TO-92	7-25	5000 Units / Bulk
BC337-25RL1	TO-92	7-25	2000 / Tape & Reel
BC337-25ZL1	TO-92	7-25	2000 / Tape & Ammunition
BC337-25ZL1G	TO-92 (Pb-Free)	8-25	2000 / Tape & Ammunition
BC337-40	TO-92	7-40	5000 Units / Bulk
BC337-40RL1	TO-92	7-40	2000 / Tape & Reel
BC337-40ZL1	TO-92	7-40	2000 / Tape & Ammunition
BC338-25ZL1	TO-92	8-25	2000 / Tape & Ammunition

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# BC337, BC337-16, BC337-25, BC337-40, BC338-25

## PACKAGE DIMENSIONS

TO-92 (TO-226)  
CASE 29-11  
ISSUE AL



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

### STYLE 17:

1. COLLECTOR
2. BASE
3. EMITTER

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